

Title (en)  
PROCESS FOR PRODUCING TRICHLOROSILANE WITH STRUCTURE-OPTIMISED SILICON PARTICLES

Title (de)  
VERFAHREN ZUR HERSTELLUNG VON TRICHLORSILAN MIT STRUKTUROPTIMIERTEN SILICIUM-PARTIKELN

Title (fr)  
PROCÉDÉ DE PRODUCTION DE TRICHLOROSILANE COMPRENNANT DES PARTICULES DE SILICIUM À STRUCTURE OPTIMISÉE

Publication  
**EP 3976533 A1 20220406 (DE)**

Application  
**EP 19728926 A 20190529**

Priority  
EP 2019064116 W 20190529

Abstract (en)  
[origin: WO2020239228A1] The invention provides a process for producing chlorosilanes which are selected from the general formula (1): H<sub>n</sub>SiCl<sub>4-n</sub> and (2): H<sub>m</sub>Cl<sub>6-m</sub>Si<sub>2</sub>, in which n denotes values from 0 to 3 and m denotes values from 0 to 4, in a fluidized bed reactor in which a reaction gas comprising hydrogen chloride is reacted using a particulate catalyst material comprising silicon, at temperatures from 280 to 400 °C, wherein the working granulate, denoting the granules or granular mixture introduced into the fluidized bed reactor, comprises 1 mass % of particles S comprising silicon, said particles being described by a structural parameter S, with S having a value of at least 0 and being calculated as follows: equation (1), where φS is the symmetry-weighted sphericity factor, ρ<sub>SD</sub> is the bulk density [g/cm<sup>3</sup>], and ρ<sub>F</sub> is the mean particulate solids density [g/cm<sup>3</sup>].

IPC 8 full level  
**C01B 33/107** (2006.01)

CPC (source: EP KR US)  
**C01B 33/10742** (2013.01 - EP KR); **C01B 33/10763** (2013.01 - EP KR US)

Designated contracting state (EPC)  
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)  
BA ME

DOCDB simple family (publication)  
**WO 2020239228 A1 20201203**; CN 113905983 A 20220107; EP 3976533 A1 20220406; JP 2022534930 A 20220804;  
JP 2024028751 A 20240305; KR 20220013417 A 20220204; TW 202043148 A 20201201; TW I744873 B 20211101;  
US 2022234901 A1 20220728

DOCDB simple family (application)  
**EP 2019064116 W 20190529**; CN 201980096907 A 20190529; EP 19728926 A 20190529; JP 2021570379 A 20190529;  
JP 2023199272 A 20231124; KR 20217043171 A 20190529; TW 109113713 A 20200424; US 201917614958 A 20190529